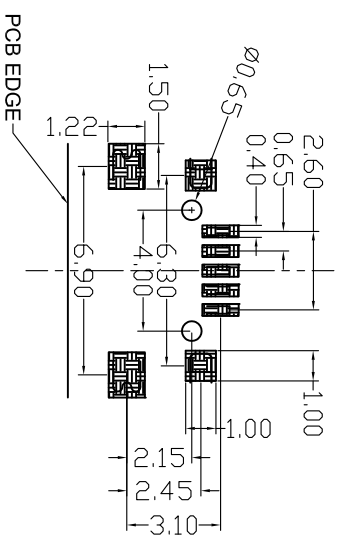
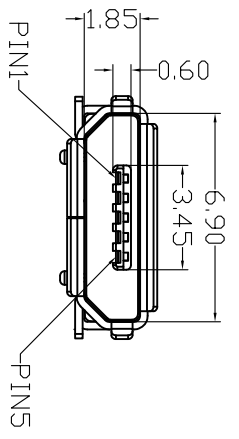
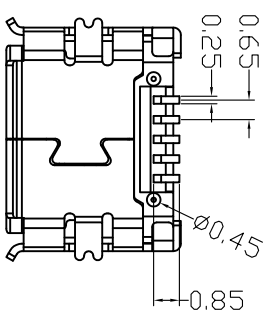
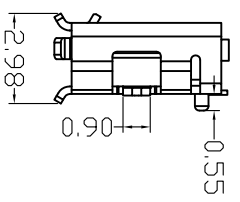
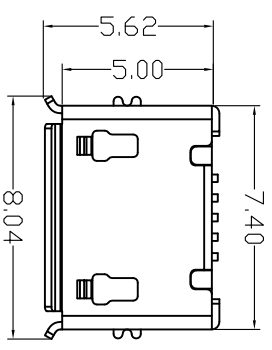
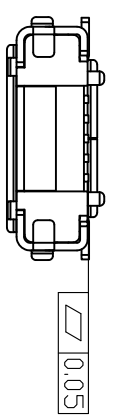


REV.	DESCRIPTION	DRAWN/DATE	APPROVED/DATE



**NOTES:**

1. MATERIAL:
  - 1.1 HOUSING: THERMOPLASTIC FLAMMABILITY RATING UL94-0
  - 1.2 CONTACT: COPPERY ALLOY T=0.15MM
  - 1.3 SHELL: COPPERY ALLOY T=0.25MM
2. FINISH:
  - 2.1 CONTACT: 3U"MIN, PLATED ON CONTACT AREA G/F PLATING ON SOLDER TAIL AREA 50~80U" NICKEL UNDERPLATING OVERALL
  - 2.2 SHELL: 80~120U" MATTER TIN PLATING ALL 50~80U" NICKEL UNDERPLATING OVERALL
3. SPECIFICATION:
  - 3.3 CURRENT RATING: 0.5A(2.3.4CONTACT)/1.8A (1.5CONTACT)MAX.
  - 3.2 VOLTAGE: 30 VAC
  - 3.3 TEMPERATURE RANGE: -30°C~85°C
  - 3.4 CONTACT RESISTANCE: 30 MILLIONHM MAX.
  - 3.5 DIELECTRIC WITHSTANDING VOLTAGE: 250VAC R.M.S
  - 3.6 INSULATION RESISTANCE: 100 MEGOHMS MIN

GENERAL TOLERANCE	ANGLE TOLERANCE	DESIGN	DATE
X. ±0.35 X. ±0.25 .XX ±0.15 .XXX ±0.10	X. ±2.0° X. ±1.0° .XX ±0.5°	ZQL	05/20/2013
UNIT: mm	SCALE: 1:1	CHECK ZQL	DATE 05/20/2013
A4	SHEET: 1 of 1	APPRO. DATE	
		FILE NAME(???)	MICRO USB 5PIN TYPE DIP SMT
		PART NO(???)	
		DRAWING NO(???)	
		REV. A0	